## **INTEGRATED CIRCUITS**

## DATA SHEET



# **74ABT02**Quad 2-input NOR gate

Product specification

1995 Sep 18

IC24 Data Handbook





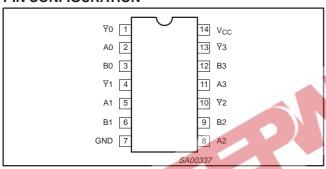
## **Quad 2-input NOR gate**

**74ABT02** 

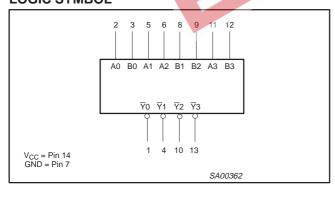
#### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS T <sub>amb</sub> = 25°C; GND = 0V	TYPICAL	UNIT
<sup>†</sup> PLH <sup>†</sup> PHL	Propagation delay An or Bn to Yn	2.4 1.8	ns	
toslh toshl	Output to Output skew	0.4	ns	
C <sub>IN</sub>	Input capacitance	V <sub>I</sub> = 0V or V <sub>CC</sub>	3	pF
Icc	Total supply current	Outputs disabled; V <sub>CC</sub> = 5.5V	50	μΑ

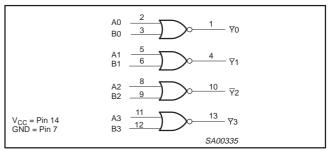
#### **PIN CONFIGURATION**



#### LOGIC SYMBOL



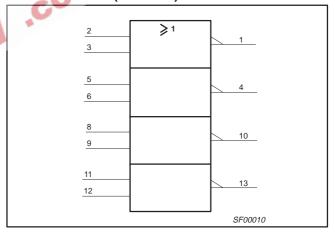
#### **LOGIC DIAGRAM**



#### **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	NAME AND FUNCTION
2, 3, 5, 6, 8, 9, 11, 12	An-Bn	Data inputs
1, 4, 10, 13	₹n	Data outputs
7 36	GND	Ground (0V)
14	Vcc	Positive supply voltage

#### LOGIC SYMBOL (IEEE/IEC)



#### **FUNCTION TABLE**

INP	JTS	OUTPUT					
An	Bn	₹n					
L	L	Н					
L	Н	L					
Н	Ĺ	Ĺ					
Н	Н	L					

#### NOTES:

H = High voltage level
L = Low voltage level

#### **ORDERING INFORMATION**

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
14-Pin Plastic DIP	–40°C to +85°C	74ABT02 N	74ABT02 N	SOT27-1
14-Pin plastic SO	-40°C to +85°C	74ABT02 D	74ABT02 D	SOT108-1
14-Pin Plastic SSOP Type II	–40°C to +85°C	74ABT02 DB	74ABT02 DB	SOT337-1
14-Pin Plastic TSSOP Type I	–40°C to +85°C	74ABT02 PW	74ABT02PW DH	SOT402-1

## Quad 2-input NOR gate

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#### ABSOLUTE MAXIMUM RATINGS1, 2

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +7.0	V
I <sub>IK</sub>	DC input diode current	V <sub>I</sub> < 0	-18	mA
V <sub>I</sub>	DC input voltage <sup>3</sup>		-1.2 to +7.0	V
I <sub>OK</sub>	DC output diode current	V <sub>O</sub> < 0	-50	mA
V <sub>OUT</sub>	DC output voltage <sup>3</sup>	output in Off or High state	-0.5 to +5.5	V
I <sub>OUT</sub>	DC output current	output in Low state	40	mA
T <sub>stg</sub>	Storage temperature range		-65 to 150	°C

#### NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
   The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
   The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

#### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	表。	LIM	ITS	UNIT
STWIBOL	TAKAMETEK	1	MIN	MAX	ONIT
V <sub>CC</sub>	DC supply voltage	04	4.5	5.5	V
V <sub>I</sub>	Input voltage		0	V <sub>CC</sub>	V
V <sub>IH</sub>	High-level input voltage		2.0		V
V <sub>IL</sub>	Low-level input voltage			0.8	V
I <sub>OH</sub>	High-level output current			<b>–15</b>	mA
I <sub>OL</sub>	Low-level output current			20	mA
Δt/Δν	Input transition rise or fall rate		0	5	ns/V
T <sub>amb</sub>	Operating free-air temperature range		-40	+85	°C

#### DC ELECTRICAL CHARACTERISTICS

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	Tai	<sub>mb</sub> = +25	°C	T <sub>amb</sub> =	UNIT	
			MIN	TYP	MAX	MIN	MAX	1
V <sub>IK</sub>	Input clamp voltage	V <sub>CC</sub> = 4.5V; I <sub>IK</sub> = -18mA		-0.9	-1.2		-1.2	V
V <sub>OH</sub>	High-level output voltage	$V_{CC} = 4.5V$ ; $I_{OH} = -15mA$ ; $V_I = V_{IL}$ or $V_{IH}$	2.5	2.9		2.5		V
V <sub>OL</sub>	Low-level output voltage	$V_{CC} = 4.5V$ ; $I_{OL} = 20mA$ ; $V_I = V_{IL}$ or $V_{IH}$		0.35	0.5		0.5	V
I <sub>I</sub>	Input leakage current	$V_{CC} = 5.5V; V_{I} = GND \text{ or } 5.5V$		±0.01	±1.0		±1.0	μА
I <sub>OFF</sub>	Power-off leakage current	$V_{CC} = 0.0V$ ; $V_O$ or $V_I \le 4.5V$		±5.0	±100		±100	μΑ
I <sub>CEX</sub>	Output High leakage current	$V_{CC} = 5.5V$ ; $V_{O} = 5.5V$ ; $V_{I} = GND$ or $V_{CC}$		5.0	50		50	μΑ
ΙO	Output current <sup>1</sup>	$V_{CC} = 5.5V; V_O = 2.5V$	-50	-75	-180	-50	-180	mA
I <sub>CC</sub>	Quiescent supply current	$V_{CC} = 5.5V$ ; $V_I = GND \text{ or } V_{CC}$		2	50		50	μΑ
$\Delta I_{CC}$	Additional supply current per input pin <sup>2</sup>	$V_{CC}$ = 5.5V; One data input at 3.4V, other inputs at $V_{CC}$ or GND		0.25	500		500	μΑ

#### NOTES:

- 1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
- 2. This is the increase in supply current for each input at 3.4V.

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## Quad 2-input NOR gate

74ABT02

#### **AC CHARACTERISTICS**

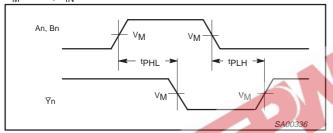
GND = 0V;  $t_R$  =  $t_F$  = 2.5ns;  $C_L$  = 50pF,  $R_L$  = 500 $\Omega$ 

SYMBOL								
	PARAMETER	WAVEFORM	T <sub>e</sub>	<sub>amb</sub> = +25° 'CC = +5.0'	C V	T <sub>amb</sub> = -40° V <sub>CC</sub> = +5	UNIT	
			MIN	TYP	MAX	MIN	MAX	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An or Bn to \( \overline{Y} \)n	1	1.0 1.0	2.4 1.8	3.7 2.8	1.0 1.0	4.4 3.4	ns
toshl toshh <sup>1</sup>	Output to Output skew An or Bn to \(\overline{Y}\)n	2		0.4 0.4	0.5 0.5		0.5 0.5	ns

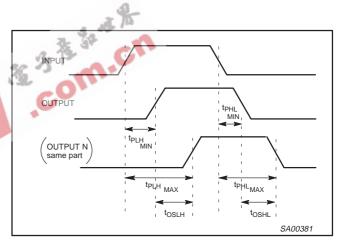
#### NOTE:

#### **AC WAVEFORMS**

 $V_{M} = 1.5V, V_{IN} = GND \text{ to } 3.0V$ 

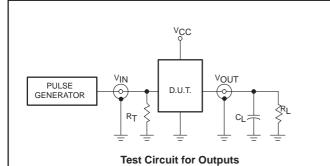


Waveform 1. Propagation delay for inverting outputs



Waveform 2. Common edge skew

#### **TEST CIRCUIT AND WAVEFORMS**



#### AMP (V) 90% NEGATIVE ٧M **PULSE** 10% 10% $t_{THL}$ $(t_F)$ tTLH (tR) tTLH (tR) tTHL (tF) AMP (V) 90% 90% POSITIVE $^{V}M$ **PULSE** 10% $V_{M} = 1.5V$

#### **Input Pulse Definition**

	INPUT PULSE REQUIREMENTS											
FAMILY	Amplitude	Rep. Rate	t <sub>W</sub>	t <sub>R</sub>	t <sub>F</sub>							
74ABT	3.0V	1MHz	500ns	2.5ns	2.5ns							

#### SH00067

#### **DEFINITIONS**

R<sub>L</sub> = Load resistor; see AC CHARACTERISTICS for value.

 $C_L = Load$  capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.

R<sub>T</sub> = Termination resistance should be equal to Z<sub>OUT</sub> of pulse generators.

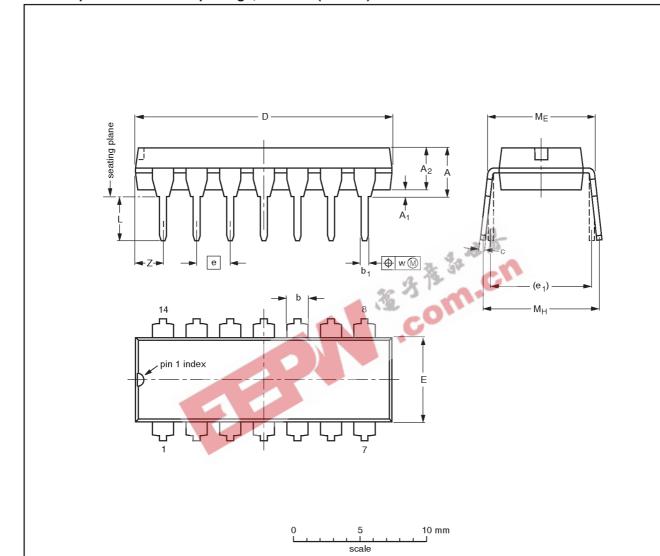
Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>); parameter guaranteed by design.

## Quad 2-input NOR gate

74ABT02

#### DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	M <sub>E</sub>	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

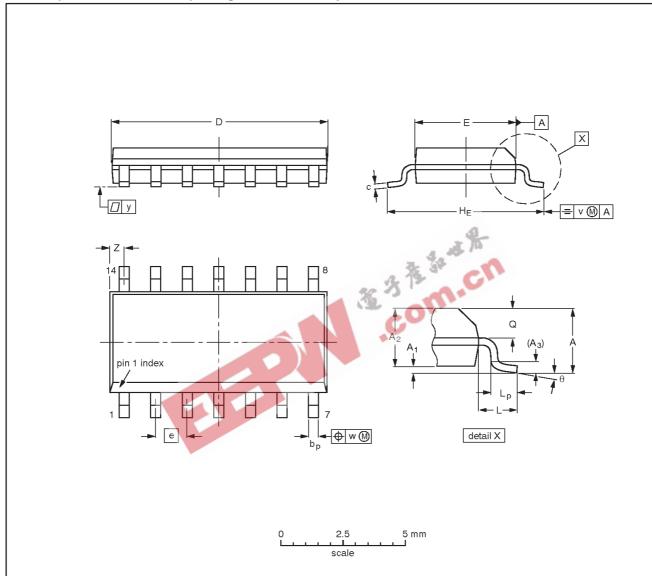
OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	ON IEC JEDEC EIAJ			PROJECTION	ISSUE DATE	
SOT27-1	050G04	MO-001AA				<del>92-11-17</del> 95-03-11

## Quad 2-input NOR gate

74ABT02

#### SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.35 0.34	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

#### Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

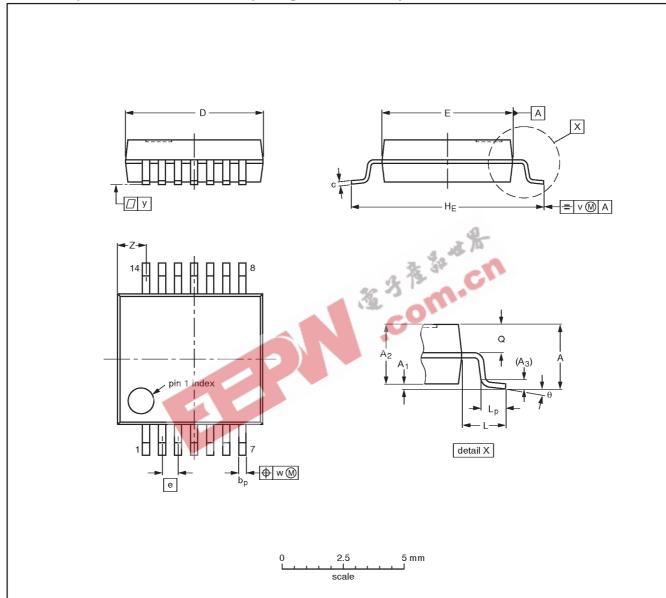
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VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT108-1	076E06S	MS-012AB			<del>-95-01-23</del> 97-05-22	

## Quad 2-input NOR gate

74ABT02

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



#### DIMENSIONS (mm are the original dimensions)

			9			-,												
UNIT	A max.	Α <sub>1</sub>	A <sub>2</sub>	<b>A</b> <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.4 0.9	8° 0°

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

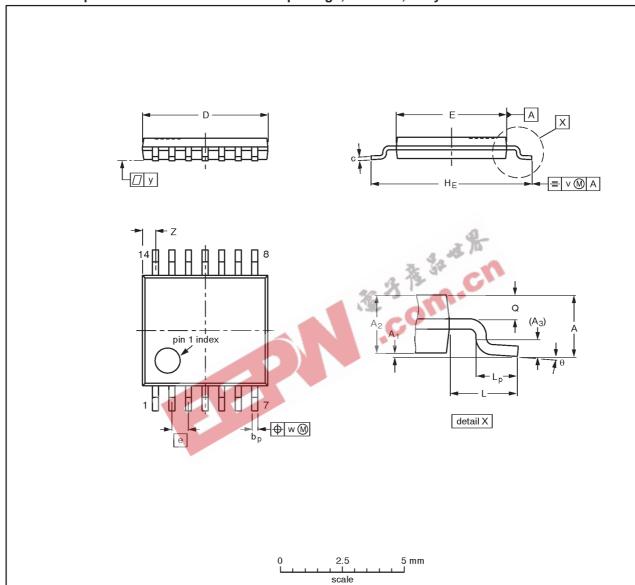
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VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT337-1		MO-150AB				<del>-95-02-04</del> 96-01-18	

## Quad 2-input NOR gate

74ABT02

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



#### DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A <sub>2</sub>	А3	bр	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ	PROJECTION	1550E DATE	
SOT402-1		MO-153			<del>-94-07-12</del> 95-04-04	

## Quad 2-input NOR gate

74ABT02

#### **NOTES**



### Quad 2-input NOR gate

74ABT02



DEFINITIONS							
Data Sheet Identification	Product Status	Definition					
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.					
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